

# VF594

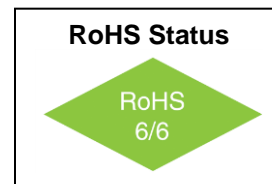
## VCXO Low Jitter 3.3V, 5.0V

### 9x14mm SMD, CMOS



#### Features

- 1.54MHz to 160MHz Frequency Range
- <0.5ps RMS Jitter over 12KHz to 20MHz
- APR to  $\pm 50$ ppm



#### Applications

- 3.3V or 5V applications
- 10 Gigabit Ethernet
- Broadband Access

#### Electrical Specifications

Parameter	Symbol	Condition	Min	Typ	Max	Unit	Note
Frequency Range	F		1.54		160	MHz	
Frequency Stability	$\Delta F/F$	Vs. Operating Temperature		$\pm 25$		ppm	
Operating Temperature	T		0° -40°		+70° +85°	°C	Order Code 1
Supply Voltage	V <sub>cc</sub>		4.75 3.15	5.00 3.30	5.25 3.45	V	Standard LV Opt.
Supply Current	I <sub>cc</sub>	No load		12		mA	@20MHz
Voltage Control	V <sub>c</sub>	V <sub>cc</sub> = 5.0V V <sub>cc</sub> = 3.3V	0 0		5.0 3.3	V	3
APR			$\pm 50$			ppm	
Integrated Jitter RMS 12KHz to 20MHz				<0.5		ps	
Input Impedance		f <sub>m</sub> <10KHz	50			KOhm	
Start-up Time	T <sub>s</sub>			2	10	ms	
Duty Cycle		@1.4V	40	50	60	%	1

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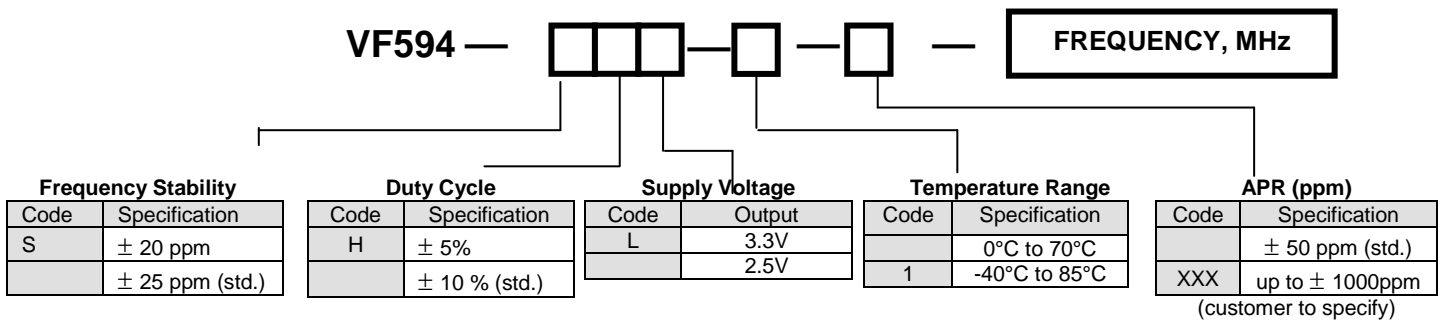
**Electrical Specifications**

Parameter	Symbol	Condition	Min	Typ	Max	Unit	Note
Modulation BW	fm	@Vc = 2.5V	10			KHz	@-3db
Deviation Slope		Monotonic, positive		50 70		ppm/V	5.0V 3.3V
Linearity					± 20	%	
Setability (Vc for center freq)	Vc0	@25°C, Fnominal	2.00 1.25	2.50 1.65	3.00 2.05	V	5.0V 3.3V
Load	10 TTL gates or 50pF MAX, AC coupled 50 Ohm termination recommended @ Freq. >54MHz						
Output High Voltage	V <sub>OH</sub>	Max Load	0.9Vcc			V	
Output Low Voltage	V <sub>OL</sub>	Max Load			0.1Vcc	V	
Rise/Fall Time	Tr/Tf	20% to 80%			6	ns	2

**Absolute Maximum Ratings**

Parameter	Symbol	Condition	Min	Typ	Max	Unit	Note
Lead Temperature		Soldering, 10s max			+260°	°C	
Storage Temperature	Ts		-55		+85°	°C	
Supply Voltage	Vc		-1		9	V	

**How to Order**

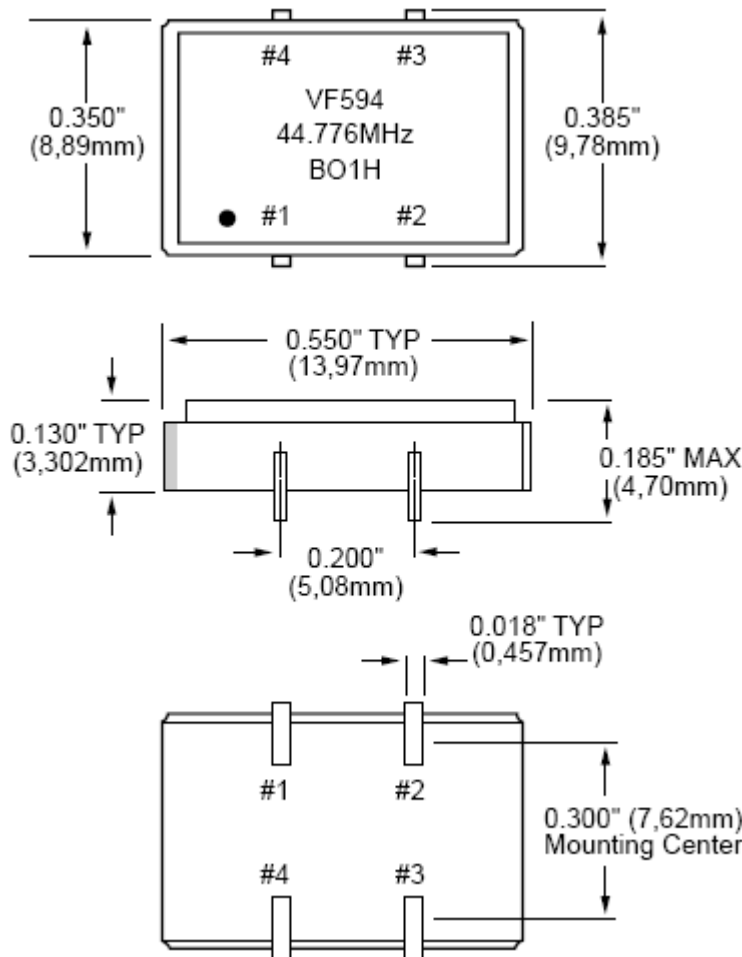


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**Environmental and Mechanical Conditions**

Parameter	Specification
Mechanical Shock	Per MIL-STD-202, Method 213, Cond. E
Thermal Shock	Per MIL-STD-883, Method 1011, Cond. A
Vibration	Per MIL-STD-883, Method 2007, Cond. A
Hermetic Seal	Leak rate less than $5 \times 10^{-8}$ atm.cc/s of helium



Pin #	Connections
1	Vc
2	Ground, Case
3	Output
4	Vcc